



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



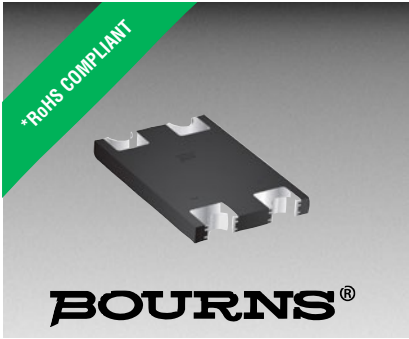
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Features

- RoHS compliant*
- Low power loss and high efficiency
- High current capability
- Low profile package

Applications

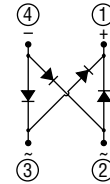
- AC operated products
- Computer monitors
- Set-top boxes
- Cable modems

CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Bridge Rectifier Diodes for rectification applications in compact chip package 0.23" x 0.20" size format, which offers PCB real estate savings and are considerably smaller than standard parts. The Bridge Rectifier Diodes offer a forward current of 2 A with a choice of repetitive peak reverse voltages between 600 V and 1000 V.



Absolute Maximum Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD-						Unit
		MBL206S	MBL208S	MBL210S	MBL206SL	MBL208SL	MBL210SL	
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	600	800	1000	600	800	1000	V
Maximum Average Forward Rectified Current (T _A = 55 °C)	I _{F(AV)}	2.0						A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	50.0			60.0			A
Operating Temperature Range	T _J	-55 to +175						°C
Storage Temperature Range	T _{STG}	-55 to +175						°C

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD-MBL2xxS(L)				Unit	
		Test Conditions		Min.	Typ.		Max.
Instantaneous Forward Voltage	V _F	I _F = 2 A	CD-MBL2xxS		0.95	1.0	V
			CD-MBL2xxSL		0.94	0.96	
Repetitive Peak Reverse Current	I _{RRM}	V _R = V _{RRM}	T _A = +25 °C		0.08	5.0	μA
Junction Capacitance	C _J	V _R = 4 V, f = 1.0 MHz	CD-MBL2xxS		25		pF
			CD-MBL2xxSL		35		
Thermal Resistance, Junction to Air (1)	R _{θJA}				95		°C / W
					95		
Thermal Resistance, Junction to Lead (1)	R _{θJL}				15		°C / W
					15		

NOTE 1: Measured when mounted on PCB with 5.0 mm x 5.0 mm (0.2" x 0.2") copper pad areas.

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

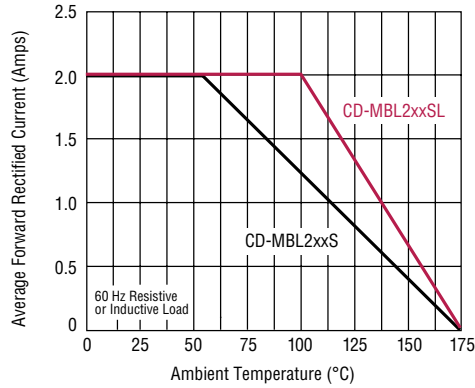
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

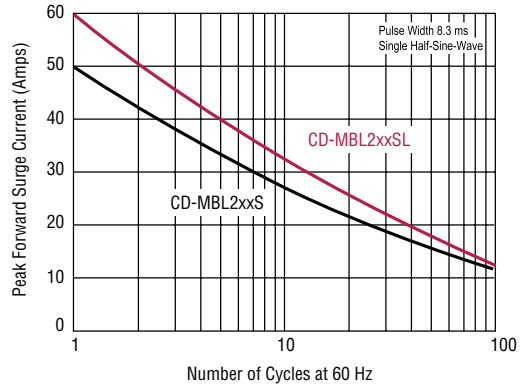


Rating and Characteristic Curves

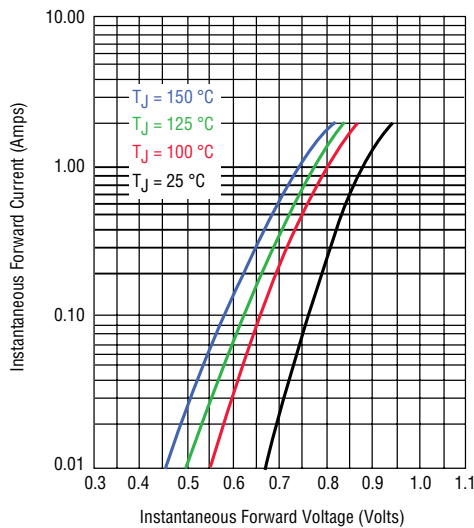
Forward Current Derating Curve



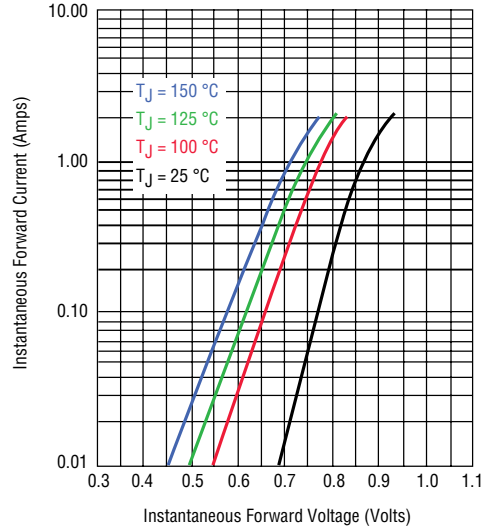
Maximum Non-Repetitive Peak Forward Surge Current



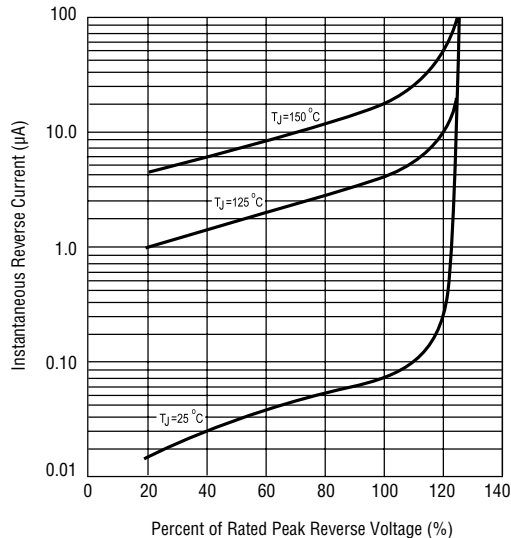
Forward Characteristics (CD2320-B2xxx)



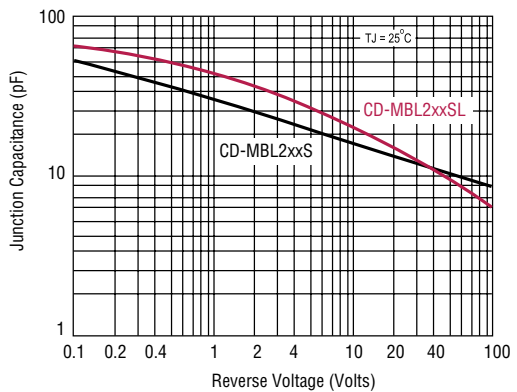
Forward Characteristics (CD-MBL2xxS(L))



Reverse Characteristics



Typical Junction Capacitance



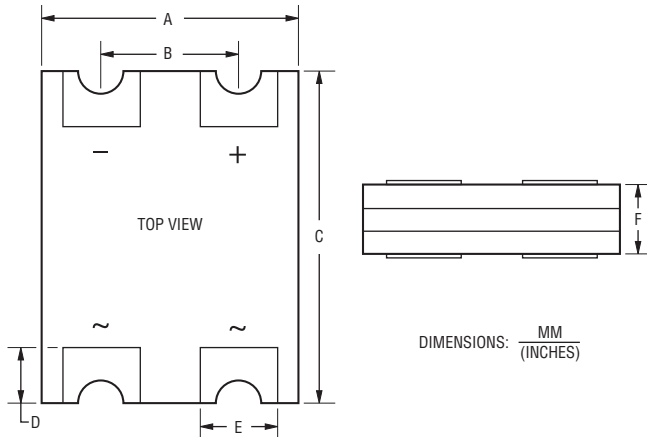
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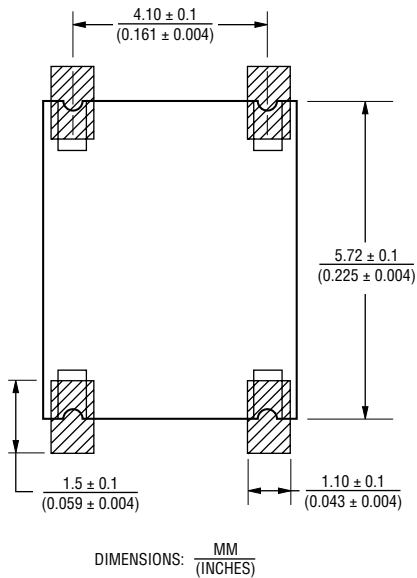
Product Dimensions

This is an RoHS2 compliant product, packaged with FRP substrate and is epoxy underfilled. The terminals are pure tin plated (lead free) and are solderable per MIL-STD-750, Method 2026. The package and dimensions are shown below.

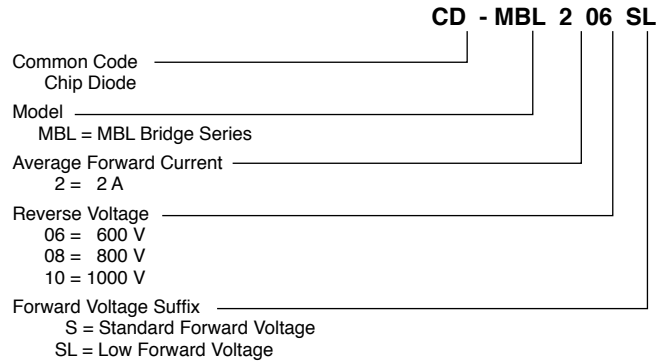


Dimensions	
A	$\frac{5.20 - 5.40}{(0.205 - 0.213)}$
B	$\frac{4.10 - 4.30}{(0.161 - 0.169)}$
C	$\frac{5.70 - 5.90}{(0.224 - 0.232)}$
D	$\frac{1.00 - 1.20}{(0.039 - 0.047)}$
E	$\frac{0.85 - 0.95}{(0.033 - 0.037)}$
F	$\frac{1.05 - 1.35}{(0.0413 - 0.0531)}$

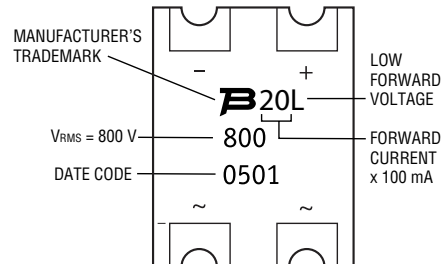
Recommended Footprint



How to Order



Typical Part Marking



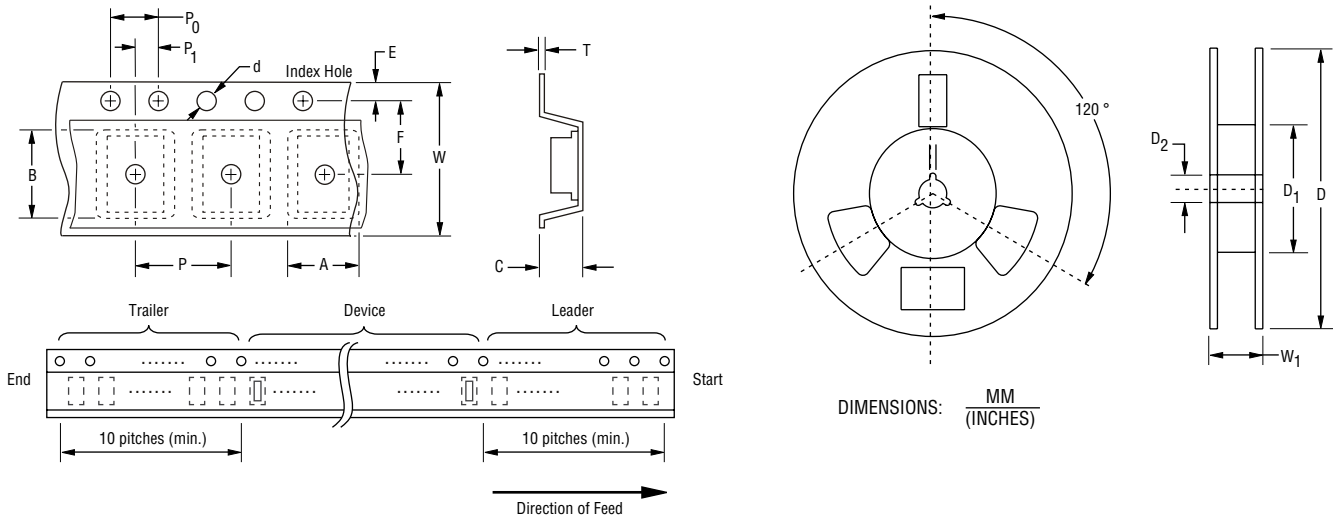
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CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

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Packaging Information

The surface mount product is packaged in a 12 mm x 8 mm tape and reel format per EIA-481 standard.



Item	Symbol	CD-MBL2xxS(L)
Carrier Width	A	$\frac{5.90 \pm 0.10}{(0.232 \pm 0.004)}$
Carrier Length	B	$\frac{6.50 \pm 0.10}{(0.256 \pm 0.004)}$
Carrier Depth	C	$\frac{1.50 \pm 0.10}{(0.059 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{330}{(12.992)}$
Reel Inner Diameter	D ₁	$\frac{50.0}{(1.969)}$ MIN.
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{5.50 \pm 0.05}{(0.217 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{12.00 \pm 0.20}{(0.472 \pm 0.008)}$
Reel Width	W ₁	$\frac{18.7}{(0.736)}$ MAX.
Quantity per Reel	--	5,000

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